Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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DATA SHEET



MOS FIELD EFFECT TRANSISTOR

NP88N055ELE, NP88N055KLE

NP88N055CLE, NP88N055DLE, NP88N055MLE, NP88N055NLE

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

These products are N-channel MOS Field Effect Transistors designed for high current switching applications.

ORDERING INFORMATION <R>

PART NUMBER	LEAD PLATING	PACKING	₩ PACKAGE	
NP88N055ELE-E1-AY Note1, 2			TO 000 (MD 057 I) by 4.4 m	
NP88N055ELE-E2-AY Note1, 2	Dona Ca (Tia)	Tana 000 a/aaal	TO-263 (MP-25ZJ) typ. 1.4 g	
NP88N055KLE-E1-AY Note1	Pure Sn (Tin)	Tape 800 p/reel	70 000 (MD 057(0) L 4.5 .	
NP88N055KLE-E2-AY Note1		.0	TO-263 (MP-25ZK) typ. 1.5 g	
NP88N055CLE-S12-AZ Note1, 2	Sn-Ag-Cu		TO-220 (MP-25) typ. 1.9 g	
NP88N055DLE-S12-AY Note1, 2		T 1: 10 . (1)	TO-262 (MP-25 Fin Cut) typ. 1.8 g	
NP88N055MLE-S18-AY Note1	Pure Sn (Tin)	Tube 50 p/tube	Tube 50 p/tube	TO-220 (MP-25K) typ. 1.9 g
NP88N055NLE-S18-AY Note1			TO-262 (MP-25SK) typ. 1.8 g	

Notes 1. Pb-free (This product does not contain Pb in the external electrode.)

2. Not for new design

FEATURES

- Channel temperature 175 degree rated
- Super low on-state resistance

 $R_{DS(on)1} = 5.2 \text{ m}\Omega$ MAX. (Vgs = 10 V, ID = 44 A)

 $R_{DS(on)2} = 6.3 \text{ m}\Omega$ MAX. (Vgs = 5.0 V, ID = 44 A)

 $R_{DS(on)3} = 6.8 \text{ m}\Omega$ MAX. (Vgs = 4.5 V, ID = 44 A)

Low input capacitance

Ciss = 9700 pF TYP.

• Built-in gate protection diode





(TO-262)



(TO-263)



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Not all products and/or types are available in every country. Please check with an NEC Electronics sales representative for availability and additional information.



ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (V _{GS} = 0 V)	VDSS	55	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C) Note1	I _{D(DC)}	±88	Α
Drain Current (pulse) Note2	I _{D(pulse)}	±352	Α
Total Power Dissipation (T _A = 25°C)	Рт	1.8	W
Total Power Dissipation (Tc = 25°C)	PT	288	W
Channel Temperature	Tch	175	°C
Storage Temperature	Tstg	-55 to +175	°C
Single Avalanche Current Note3	las	75/88	Α
Single Avalanche Energy Note3	Eas	562/232	mJ

Notes 1. Calculated constant current according to MAX. allowable channel temperature.

- **2.** PW \leq 10 μ s, Duty cycle \leq 1%
- 3. Starting T_{ch} = 25°C, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V (see Figure 4.)

THERMAL RESISTANCE

Channel to Case Thermal Resistance Rth(ch-C) 0.52 °C/W
Channel to Ambient Thermal Resistance Rth(ch-A) 83.3 °C/W

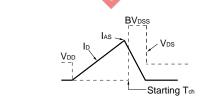


ELECTRICAL CHARACTERISTICS (TA = 25°C)

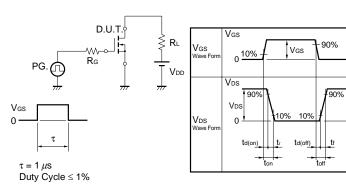
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 55 V, V _{GS} = 0 V			10	μΑ
Gate Leakage Current	Igss	V _{GS} = ±20 V, V _{DS} = 0 V			±10	μΑ
Gate to Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	1.5	2.0	2.5	V
Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 44 A	38	75		S
Drain to Source On-state Resistance	R _{DS(on)1}	V _{GS} = 10 V, I _D = 44 A		4.1	5.2	mΩ
	R _{DS(on)2}	V _{GS} = 5.0 V, I _D = 44 A		4.8	6.3	mΩ
	RDS(on)3	V _{GS} = 4.5 V, I _D = 44 A		5.1	6.8	mΩ
Input Capacitance	Ciss	V _{DS} = 25 V,		9700	14600	pF
Output Capacitance	Coss	$V_{GS} = 0 V$,		1100	1700	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		490	890	pF
Turn-on Delay Time	t _{d(on)}	V _{DD} = 28 V, I _D = 44 A,	,	37	82	ns
Rise Time	tr	V _G S = 10 V,		22	56	ns
Turn-off Delay Time	t _{d(off)}	$R_G = 1 \Omega$		180	360	ns
Fall Time	t f	_40		35	88	ns
Total Gate Charge	Q _{G1}	V _{DD} = 44 V, V _{GS} = 10 V, I _D = 88 A		160	240	nC
	Q _{G2}	V _{DD} = 44 V,		88	140	nC
Gate to Source Charge	Qgs	V _{GS} = 5.0 V,		27		nC
Gate to Drain Charge	Q _{GD}	In = 88 A		48		nC
Body Diode Forward Voltage	V _F (S-D)	I _F = 88 A, V _{GS} = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 88 A, V _{GS} = 0 V,		62		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>μ</i> s		120		nC

TEST CIRCUIT 1 AVALANCHE CAPABILITY

$\begin{array}{c} \text{D.U.T.} \\ \text{Rg} = 25 \ \Omega \\ \text{Vgs} = 20 \rightarrow 0 \ \text{V} \end{array} \begin{array}{c} \text{PG.} \\ \text{Fig. } \\ \text{Fig. } \\ \text{Fig. } \\ \text{Fig. } \end{array}$



TEST CIRCUIT 2 SWITCHING TIME



TEST CIRCUIT 3 GATE CHARGE

TYPICAL CHARACTERISTICS (TA = 25°C)



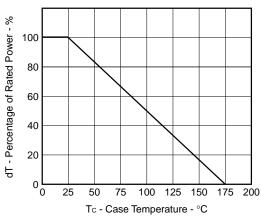
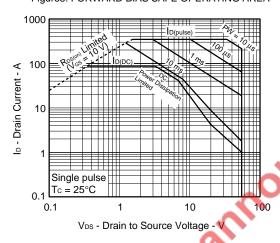


Figure 3. FORWARD BIAS SAFE OPERATING AREA



0.01

 10μ

100 μ

1 m

Figure 2. TOTAL POWER DISSIPATION vs. CASE TEMPERATURE

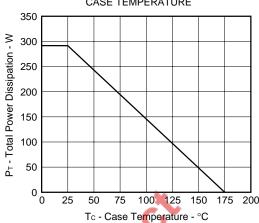
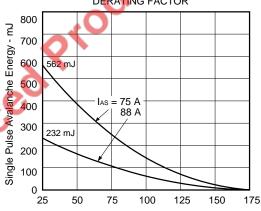
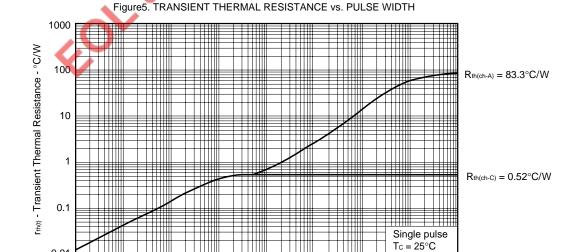


Figure4. SINGLE AVALANCHE ENERGY DERATING FACTOR



Starting T_{ch} - Starting Channel Temperature - $^{\circ}$ C



10

100

1000

100 m PW - Pulse Width - s

10 m

Figure 6. FORWARD TRANSFER CHARACTERISTICS

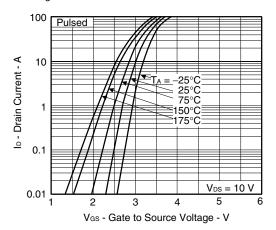


Figure 8. FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

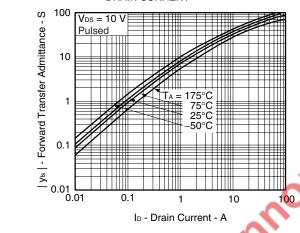


Figure 10. DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

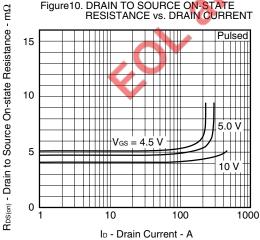
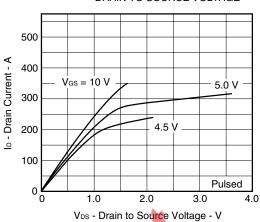


Figure 7. DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



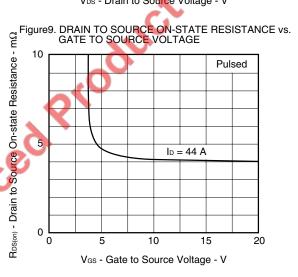
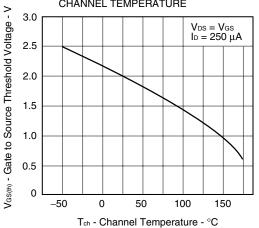
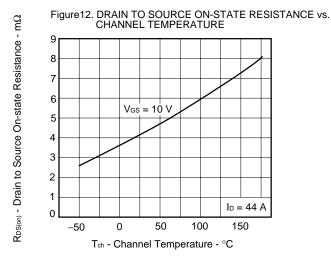
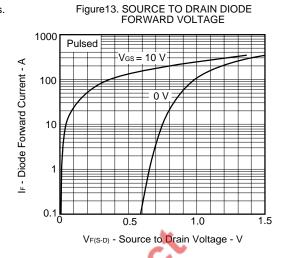
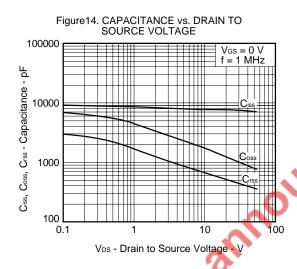


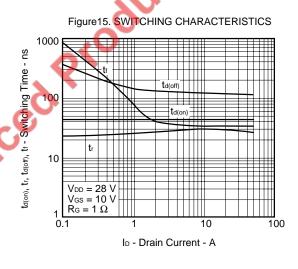
Figure 11. GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE

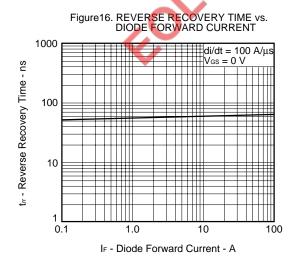


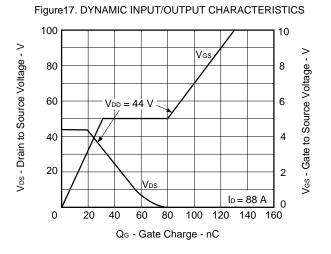






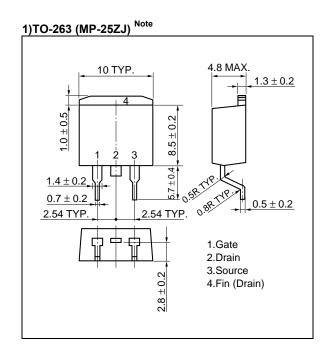


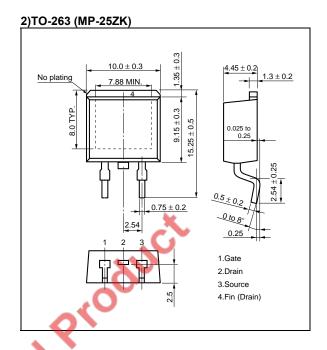


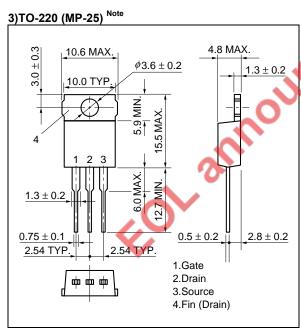


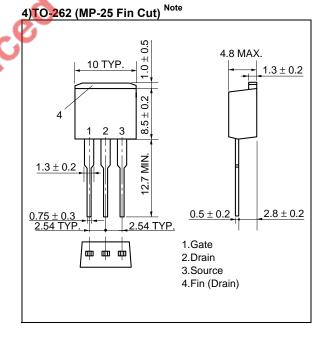


<R> PACKAGE DRAWINGS (Unit: mm)

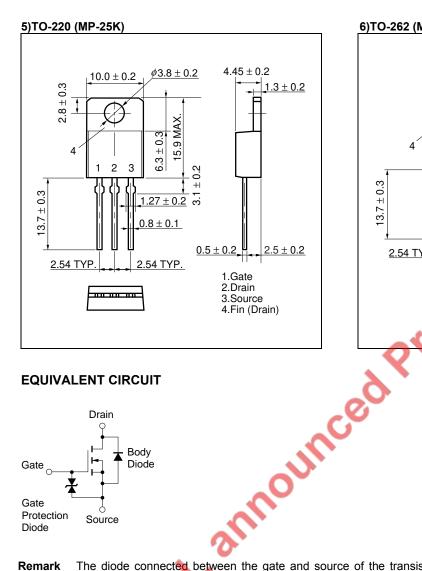


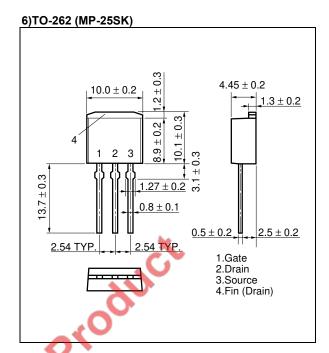




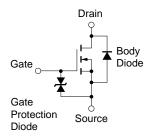


Note Not for new design





EQUIVALENT CIRCUIT

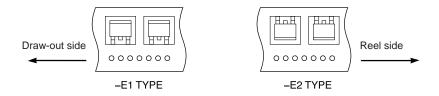


The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

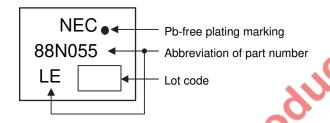


<R> TAPE INFORMATION

There are two types (-E1, -E2) of taping depending on the direction of the device.



<R> MARKING INFORMATION



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These products should be soldered and mounted under the following recommended conditions.

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For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

Soldering Method	Soldering Conditions	Recommended Condition Symbol	
Infrared reflow	Maximum temperature (Package's surface temperature): 260°C or below		
MP-25ZJ, MP-25ZK	Time at maximum temperature: 10 seconds or less		
. (Time of temperature higher than 220°C: 60 seconds or less	IDC0 00 0	
	Preheating time at 160 to 180°C: 60 to 120 seconds	IR60-00-3	
	Maximum number of reflow processes: 3 times		
	Maximum chlorine content of rosin flux (percentage mass): 0.2% or less		
Wave soldering	Maximum temperature (Solder temperature): 260°C or below		
MP-25, MP-25K, MP-25SK,	Time: 10 seconds or less	THDWS	
MP-25 Fin Cut	Maximum chlorine content of rosin flux: 0.2% (wt.) or less		
Partial heating	Maximum temperature (Pin temperature): 350°C or below		
MP-25ZJ, MP-25ZK,	Time (per side of the device): 3 seconds or less	P350	
MP-25K, MP-25SK	Maximum chlorine content of rosin flux: 0.2% (wt.) or less		
Partial heating	Maximum temperature (Pin temperature): 300°C or below		
MP-25, MP-25 Fin Cut	Time (per side of the device): 3 seconds or less	P300	
	Maximum chlorine content of rosin flux: 0.2% (wt.) or less		

Caution Do not use different soldering methods together (except for partial heating).



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